

L Number	Hits	Search Text	DB	Time stamp
-	1805	disposable near2 electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/24 17:16
-	66	(disposable near2 electrode) with flow	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/24 17:50
-	1078	flow and working adj electrode with (layer surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/24 17:51
-	373	flow same working adj electrode with (layer surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/24 17:51
-	12202	(electrode anode cathode) with (polyester polycarbonate polyimide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:05
-	3876	((electrode anode cathode) with (polyester polycarbonate polyimide)) with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:05
-	373	(electrode anode cathode) with (polyester polycarbonate polyimide) near substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:05
-	8	((electrode anode cathode) with (polyester polycarbonate polyimide) near substrate) and disposable	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:21
-	9	disposable with (electrode anode cathode) with (PVD CVD (vapor adj deposition))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:22
-	23	disposable with (electrode anode cathode) same (PVD CVD (vapor adj deposition))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:40
-	470	(CVD PVD) same titanium same gold	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:41
-	1226	((vapor adj deposition) CVD PVD) same titanium same gold	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:41
-	264	((vapor adj deposition) CVD PVD) with titanium with gold	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:42
-	9	((((vapor adj deposition) CVD PVD) with titanium with gold) with adhesion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/25 15:43

-	290	sputtering with (Ta tantalum) with (polyimide polyester polycarbonate polyetherimide polyolefin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:22
-	248	(sputtering with (Ta tantalum) with (polyimide polyester polycarbonate polyetherimide polyolefin)) same (Au gold)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:16
-	246	(sputtering with (Ta tantalum) with (polyimide polyester polycarbonate polyetherimide polyolefin)) with (Au gold)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:17
-	33	((sputtering with (Ta tantalum) with (polyimide polyester polycarbonate polyetherimide polyolefin)) with (Au gold)) not photoconductive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:17
-	212	(CVD PVD ((vapor vapour) adj deposit\$4)) with (Ta tantalum) with (polyimide polyester polycarbonate polyetherimide polyolefin) with (Au gold)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:22
-	20	((CVD PVD ((vapor vapour) adj deposit\$4)) with (Ta tantalum) with (polyimide polyester polycarbonate polyetherimide polyolefin) with (Au gold)) not photoconductive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:21
-	0	(sputtering CVD PVD ((vapor vapour) adj deposit\$4)) with (Ta tantalum) with (polyimide polyester polycarbonate polyetherimide polyolefin) with (Au gold) with adhesion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:23
-	8	(sputtering CVD PVD ((vapor vapour) adj deposit\$4)) with (Ta tantalum) same (polyimide polyester polycarbonate polyetherimide polyolefin) same (Au gold) same adhesion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:58
-	7	"5755759"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:54
-	2	(sputtering CVD PVD ((vapor vapour) adj deposit\$4)) with (Ti Titanium!) with (polyimide polyester polycarbonate polyetherimide polyolefin) with (Au gold) with adhesion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:59
-	2	((sputtering CVD PVD ((vapor vapour) adj deposit\$4)) with (Ti Titanium!) with (polyimide polyester polycarbonate polyetherimide polyolefin) with (Au gold) with adhesion) not photoconductive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 13:59
-	11	(sputtering CVD PVD ((vapor vapour) adj deposit\$4)) with (Ti Titanium!) with (polyimide polyester polycarbonate polyetherimide polyolefin) same (Au gold) same adhesion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:00
-	24	(sputtering CVD PVD ((vapor vapour) adj deposit\$4)) with (Ti Titanium!) same (polyimide polyester polycarbonate polyetherimide polyolefin) same (Au gold) same adhesion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:10
-	9802	lead with contact with (area region)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:10

-	196	(lead with contact with (area region)) with gold	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:10
-	4	((lead with contact with (area region)) with gold) with planar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:11
-	725	(lead with contact with (area region)) and (electrochemical electrolytic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:12
-	21	((lead with contact with (area region)) with gold) and (electrochemical electrolytic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:22
-	14173	electrical adj contact with spring	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:17
-	103	(electrical adj contact with spring) with gold	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:21
-	0	((electrical adj contact with spring) with gold) and disposable adj electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:21
-	1	((electrical adj contact with spring) with gold) and disposable	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:21
-	26	((electrical adj contact with spring) with gold) and (electrochemical electrolytic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 14:22
-	6234	working and counter and reference and electrode and flow	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 16:39
-	5457	working and counter and reference and electrode and flow and surfaces	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 16:40
-	660	working and counter and reference and electrode and flow and surfaces and (bolt nut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 16:40
-	532	working and counter and reference and electrode and flow and surfaces and (bolt nut)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 16:40
-	1	working and counter and reference and electrode and flow and surfaces and (bolt nut)	EPO; JPO; DERWENT; IBM_TDB	2003/09/29 16:40